Technical Description

The brief circuit description is listed as below:

- 1) U1 and U2 act as Voltage Regulators (RPZ100C40M/TX6250SP33R).
- 2) U3 acts as a BLE Module (TNT-BT-AAN-B7493-A).
- 3) U4 acts as a MCU (GPCE4096A).
- 4) U6 acts as a Flash (GPR25L3203F).
- 5) Y1 acts as a Crystal for U3.
- 6) X1 acts as a Crystal for U4.

Antenna Type: Internal antenna

Antenna Gain: 0dBi

Nominal rated field strength: 97.0 dBµV/m at 3m

Maximum allowed field strength of production tolerance: +/- 2dB



Bluetooth BLE

Module Datasheet

TNT-BT_M

Release 1.00

May, 07, 2015

Revision History

Revision	Date	Description	Author
1.00	May. 07. 15	Initial version.	

1. Introduction:

Bluetooth low energy (or Bluetooth LE, or BLE, marketed as **Bluetooth Smart**) is a wireless computer network technology designed and marketed by the not-for-profit, non-stock corporation Bluetooth SIG which is aimed at novel applications in the healthcare, fitness, security, and home entertainment industries.. Compared to "Classic" Bluetooth, BLE is intended to provide considerably reduced power consumption and lower cost, while maintaining a similar communication range.

The Bluetooth SIG defines many profiles for Low Energy devices: a profile is a specification for how a device works in a particular application.

- Health care profiles
- Sports and fitness profiles
- Proximity sensing
- Alerts and time profiles

2. Key Features:

- Ultra-low peak, average and idle mode power consumption
- Ability to run for years on standard, coin-cell batteries
- Low cost
- Multi-vendor interoperability
- Enhanced range

3-1. Module Specification:

Radio Frequency	2.4GHz ISM		
Operation Distance	10 Meters		
Power Supply	Button cell battery / Li-ion Bat		
Consumption Current(working)	6mA		
Sleeping Mode	4uA		
Antenna	PCB		
Pairing	BLE Pairing		

Radio Frequency	2.4GHz ISM	
Operation Distance	10 Meters	
Low Voltage Detection	Yes	
PWM	Yes	
Interface	I2C / SPI / UART	

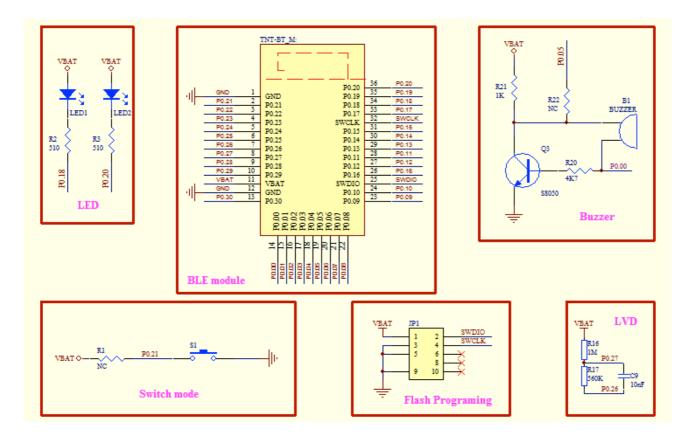
3-2. DC Electrical Specification:

Parameter	Sym.	Specification				Test Conditions
rarameter	Sylli.	Min.	TYP.	Max.	Unit	Test Conditions
Operation voltage	VDD	1.8	3.0	3.6	V	
Power Ground	VSS AVSS	0			V	
Operating Current	Active		2		mA	VDD = 3V
Operating Current	Sleep		4		uA	
IO Leakage Current	ILK	-2	-	+2	m A	
IO Source Current	Digital I/O	0.5		5	mA	

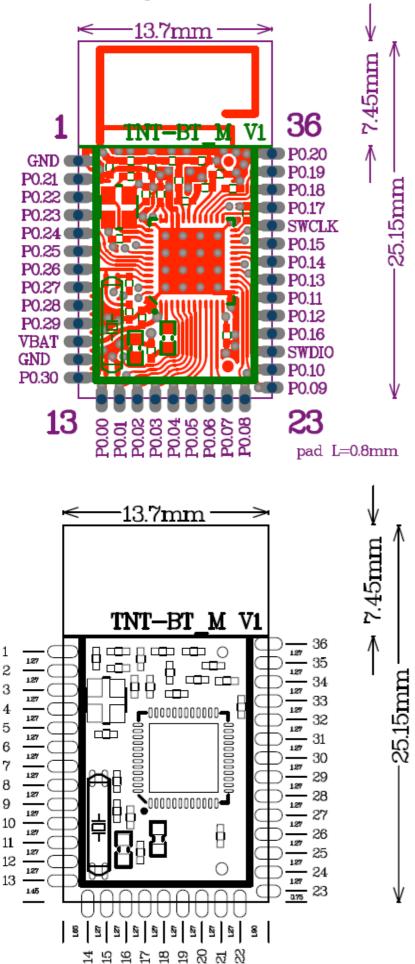
3-3. Radio Frequency Specification:

Parameter		Spec	cification	Test Conditions	
Farameter	Min.	TYP.	Max.	Unit	Test Conditions
Working Frequency	2400		2483	MHz	
Transmission Power		4		dBm	VDD = 3V
Receiver Sensitivity (1Mbps)		-90		dBm	VDD = 3V
On Air Symbol Rate	250		2000	bps	

3-4. Application Circuit:



3-5. Pin Assignment:



Pin No.	Pin Name	Pin Type	Description						
1	GND	P	Ground (0V)						
2	P0.21	I/O	General purpose I/O						
3	P0.22	I/O	General purpose I/O						
4	P0.23	I/O	General purpose I/O						
5	P0.24	I/O	General purpose I/O						
6	P0.25	I/O	General purpose I/O						
		I/O	General purpose I/O						
7	P0.26	AIN0	DC input0						
		XL2	Crystal connection for 32.768KHz crystal oscillator						
		I/O	General purpose I/O						
8	P0.27	AIN1	ADC input1						
		XL1	Crystal connection for 32.768KHz crystal oscillator or external 32.768KHz crystal reference						
9	P0.28	I/O	General purpose I/O						
10	P0.29	I/O	General purpose I/O						
11	VBAT	P	Power Supply						
12	GND	P	Ground (0V)						
13	P0.30	I/O	General purpose I/O						
1.4	DO 00	I/O	General purpose I/O						
14	P0.00	AREF0	ADC Reference voltage						
15	I/O		General purpose I/O						
13	P0.01	AIN2	ADC input2						
16	P0.02	I/O	General purpose I/O						
10	FU.U2	AIN3	ADC input3						
17	P0.03	I/O	General purpose I/O						
17	10.03	AIN4	ADC input4						
18	P0.04	I/O	General purpose I/O						
10	10.04	AIN5	ADC input5						
19	P0.05	I/O	General purpose I/O						
17	10.03	AIN6	ADC input6						
	P0.06	I/O	General purpose I/O						
20		AIN7	ADC input7						
		AREF1	ADC Reference voltage						
21	P0.07	I/O	General purpose I/O						
22	P0.08	I/O	General purpose I/O						
23	P0.09	I/O	General purpose I/O						
24	P0.10	I/O	General purpose I/O						
25	SWDIO	I/O	System reset(active low). Also HW debug and flash programming I/O						

26	P0.16	I/O	General purpose I/O
27	P0.12	I/O	General purpose I/O
28	P0.11	I/O	General purpose I/O
29	P0.13	I/O	General purpose I/O
30	P0.14	I/O	General purpose I/O
31	P0.15	I/O	General purpose I/O
32	SWCLK	I	HW debug and flash programming I/O
33	P0.17	I/O	General purpose I/O
34	P0.18	I/O	General purpose I/O
35	P0.19	I/O	General purpose I/O
36	P0.20	I/O	General purpose I/O